

DESCRIPTION

Product group: LED

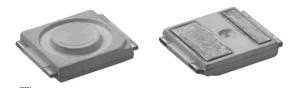
Product series: power

• Package: SMD Little Star

Angle of half intensity: ± 60°

Vishay Semiconductors

Little Star[®] 1 W Power SMD LED White



The VLMW711. is one of the most robust and light

efficient LEDs in the market. With its extremely high

level of brightness and the ultra low height profile,

which is only 1.5 mm are highly suitable for both

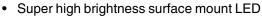
conventional lighting and specialized application such

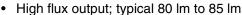
as automotive signal lights, traffic lights, channel lights,

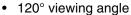
tube lights and garden lights among others.

PRODUCT GROUP AND PACKAGE DATA

FEATURESSuper high







 Compact package outline (L x W x H) of 6 x 6 x 1.5 mm



- Ultra low height profile 1.5 mm
- · Designed for high current drive; up to 350 mA
- Low thermal resistance; R_{th,IP} = 10 K/W
- Qualified according to JEDEC moisture sensitivity level 2a
- · Compatible to IR reflow soldering
- Little Star[®] are class 1M LED products. Do not view directly with optical instrument
- Compliant to RoHS directive 2002/95/EC and in accordance to WEEE 2002/96/EC
- AEC-Q101 qualified
- ESD-withstand voltage: up to 2 kV according to JESD22-A114-B

APPLICATIONS

- Automotive: exterior applications, e.g.: fog-lamp, rear mirror lighting, etc.
- · Communication: flashLED
- Industry: white goods (e.g.: oven, microwave, etc.)
- Lighting: garden light, architecture lighting, general lighting, etc.

PARTS TABLE				
PART	LUMINOUS FLUX CORRELATION BETWEEN LUM. FLUX/LUM. INTENSITY (at $I_F = 350 \text{ mA}$)	LUMINOUS INTENSITY (at I _F = 350 mA)	TECHNOLOGY	
VLMW711T3U2US-GS08	White, ϕ = (76 500 to 99 400) mlm	I _{V typ.} = 25 000 mcd	InGaN	

Document Number 81161 Rev. 1.0, 26-Mar-09

VLMW711T3U2US

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ABSOLUTE MAXIMUM RATINGS 1) VLMW711T3U2US				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Forward current		I _F	350	mA
Power dissipation		P _{tot}	1.4	W
Junction temperature		Tj	+ 120	°C
Surge current t < 10 µs, d = 0.1		I _{FM}	1000	mA
Operating temperature range		T _{amb}	- 40 to + 100	°C
Storage temperature range		T _{stg}	- 40 to + 100	°C
Thermal resistance junction/pin		R _{thJP}	10	K/W

Note:

Not designed for reverse operation

¹⁾ T_{amb} = 25 °C, unless otherwise specified

OPTICAL AND ELECTRICAL CHARACTERISTICS 1) VLMW711T3U2US, WHITE						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Luminous flux/luminous intensity	I _F = 350 mA	ф	76 500		99 400	mlm
Luminous liux/luminous intensity		I _V		25 000		mcd
Chromaticity coordinate x acc. to CIE 1931	I _F = 350 mA	х		0.37		
Chromaticity coordinate y acc. to CIE 1931	I _F = 350 mA	у		0.38		
Angle of half intensity	I _F = 350 mA	φ		± 60		deg
Forward voltage ²⁾	I _F = 350 mA	V _F	3	3.5	4	V
Temperature coefficient of V _F	I _F = 350 mA	TC _{VF}		- 3		mV/K
Temperature coefficient of I _V	I _F = 350 mA	TC _{IV}		- 0.4		%/K

Note

 $^{^{2)}}$ Forward voltages are tested at a current pulse duration of 1 ms and a tolerance of \pm 0.05 V

LUMINOUS INTENSITY/FLUX CLASSIFICATION WHITE				
GROUP	LUMINOUS FLUX ϕ_{V} (mlm) CORRELATION TABLE			
STANDARD	MIN.	MAX.		
Т3	76 500	87 400		
U2	87 400	99 400		

Note:

Luminous intensity is tested at a current pulse duration of 25 ms and an accuracy of \pm 11 %.

The above type numbers represent the order groups which include only a few brightness groups. Only one group will be shipped on each reel (there will be no mixing of two groups on each reel).

In order to ensure availability, single brightness groups will not be orderable.

In a similar manner for colors where wavelength groups are measured and binned, single wavelength groups will be shipped in any one reel. In order to ensure availability, single wavelength groups will not be orderable.

¹⁾ T_{amb} = 25 °C, unless otherwise specified





CHROMATICITY COORDIN	IATED GROUPS FOR WHITE SMD LI	ED
Bin	Сх	Су
	0.348	0.383
UM	0.367	0.400
ОΜ	0.364	0.383
	0.347	0.368
UN	0.347	0.368
	0.364	0.383
	0.362	0.372
	0.346	0.357
	0.346	0.357
	0.362	0.372
UO	0.359	0.356
	0.344	0.343
	0.344	0.343
LID	0.359	0.356
UP	0.357	0.343
	0.343	0.331
	0.367	0.400
	0.364	0.383
ТМ	0.381	0.394
	0.386	0.411
	0.364	0.383
	0.362	0.372
TN	0.378	0.381
	0.381	0.394
	0.362	0.372
T-0	0.359	0.356
ТО	0.374	0.365
	0.378	0.381
	0.359	0.356
TD	0.357	0.343
TP	0.370	0.351
	0.374	0.365
	0.386	0.411
014	0.381	0.394
SM	0.396	0.404
	0.402	0.421
	0.381	0.394
ON	0.378	0.381
SN	0.392	0.389
	0.396	0.404
so	0.378	0.381
	0.374	0.365
	0.387	0.373
	0.392	0.389
	0.374	0.365
25	0.370	0.351
SP	0.382	0.358
	0.387	0.373

Note:

Chromaticity coordinate groups are tested at a current pulse duration of 25 ms and a tolerance of \pm 0.01.

TYPICAL CHARACTERISTICS

T_{amb} = 25 °C, unless otherwise specified

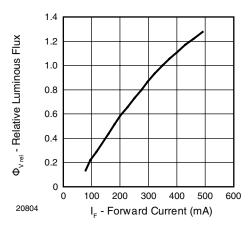


Figure 1. Relative Luminous Flux vs. Forward Current

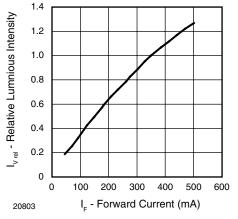


Figure 2. Relative Luminous Intensity vs. Forward Current

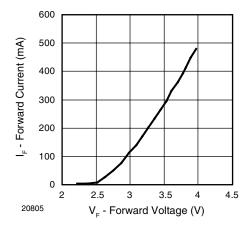


Figure 3. Forward Current vs. Forward Voltage



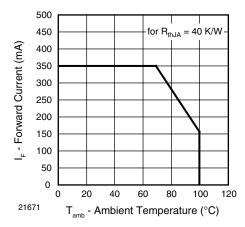


Figure 4. Max. Permissible Forward Current vs.
Ambient Temperature

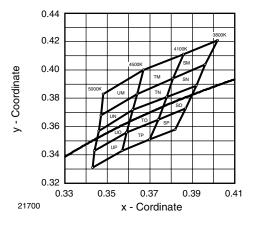


Figure 5. Coordinates of Color Groups

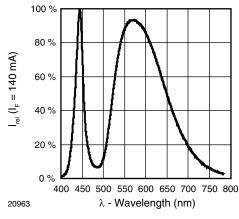


Figure 6. Relative Spectrale Emission



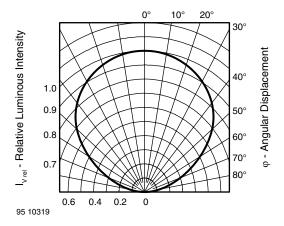
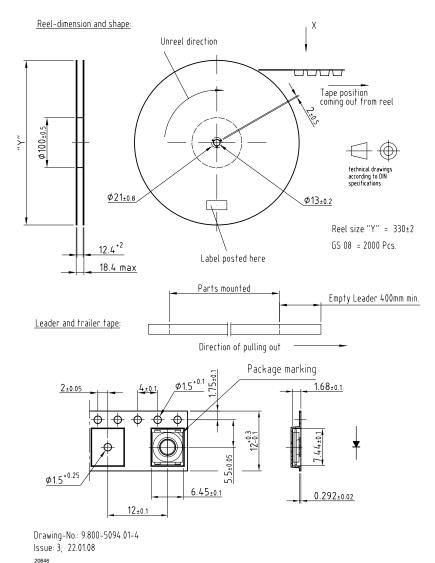


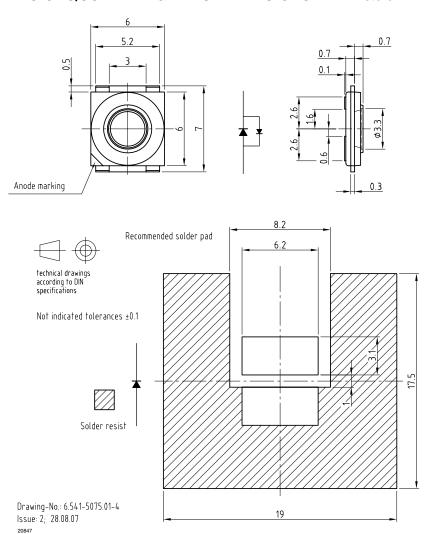
Figure 7. Relative Luminous Intensity vs. Angular Displacement

TAPING DIMENSIONS in millimeters





PACKAGE DIMENSIONS/SOLDERING PADS DIMENSIONS in millimeters



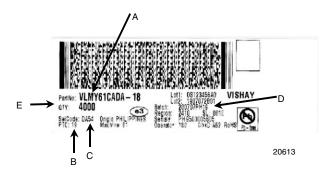
SOLDERING PROFILE

IR Reflow Soldering Profile for Lead (Pb)-free Soldering Preconditioning acc. to JEDEC Level 2a 300 max. 260 -255 °C -240 °C 250 245 °C -217 °C-Temperature (°C) max. 30 s 150 max. 100 s max. 120 s 100 max. ramp up 3 °C/s max. ramp down 6 °C/s 50 50 100 150 200 250 300 Ó Time (s) max. 2 cycles allowed

Figure 8. Vishay Lead (Pb)-free Reflow Soldering Profile (acc. to J-STD-020C)



BAR CODE PRODUCT LABEL EXAMPLE:



- A) Type of component
- B) Manufacturing plant
- C) SEL selection code (bin):

e.g.: DA = code for luminous intensity group

5 = code for color group

D) Batch:

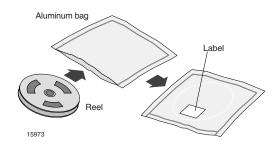
200707 = year 2007, week 07

PH19 = plant code

E) Total quantity

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 672 h under these conditions moisture content will be too high for reflow soldering.

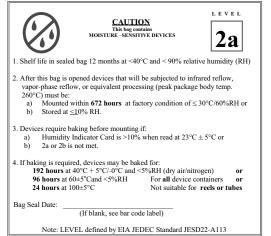
In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at $40 \,^{\circ}\text{C} + 5 \,^{\circ}\text{C/-} \, 0 \,^{\circ}\text{C}$ and $< 5 \,^{\circ}\text{KH}$ (dry air/nitrogen) or

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 100 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC standard JESD22-A112 level 2a label is included on all dry bags.



Example of JESD22-A112 level 2a label

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electro-static sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.





Vishay

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Revision: 18-Jul-08

Document Number: 91000 www.vishay.com